

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
RAJAPPA TADEPALLI	12/09/2011
KLAUS FRIEDRICH GLEICH	12/05/2011
JAWED ASRAR	12/15/2011
KIARASH ALAVI SHOOSHTARI	12/05/2011
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14844573
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NAME OF SUBMITTER:	DENIS LAVOIE
SIGNATURE:	/dl/
DATE SIGNED:	09/29/2015
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2	

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ASSIGNMENT

WHEREAS we, Rajappa Tadepalli, 9620 Timber Hawk Circle Apt 11, Highlands Ranch, Colorado 80127; Klaus Friedrich Gleich, 9637 Timber Hawk Circle, Apt. 22, Highlands Ranch, Colorado 80126; Jawed Asrar, 9483 East Arbor Drive, Englewood, Colorado 80111; and Kiarash Alavi Shooshtari, 9193 West Finland Drive, Littleton, Colorado 80127, have invented certain new and useful improvements in

PRODUCTS, METHODS FOR MAKING REINFORCED THERMOPLASTIC COMPOSITES AND COMPOSITES

for which we have signed an application for Letters Patent of the United States;

AND WHEREAS JOHNS MANVILLE, a corporation organized and existing under the laws of the State of Delaware, and having a place of business at 717 Seventeenth Street, in the City & County of Denver and State of Colorado, is desirous of acquiring the entire interest in said invention and in the said application for Letters Patent therefor, and in any Letters Patent which may be obtained therefor;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, BE IT KNOWN THAT, for good and valuable consideration, the receipt of which is hereby acknowledged, we Rajappa Tadepalli, Klaus Friedrich Gleich, Jawed Asrar and Kiarash Alavi Shooshtari, have signed and transferred, and do hereby sell, assign and transfer unto said Johns Manville, its successors and assigns, the entire right title and interest in and to the said invention as fully set forth and described in the specification forming a part of said application for Letters Patent of the United States, and in and to said application, and in and to any and all Letters Patent of the United States which may be issued thereon, and any and all Letters Patent which may be granted for said invention in foreign countries, for the use and benefit of said Johns Manville, its successors and assigns.

AND we do hereby authorize and request the U.S. Commissioner of Patents and Trademarks to issue the said Letters Patent of the United States which may be granted upon said application, or upon any divisional, continuing, substitute, reissue or renewal application or applications, to said Johns Manville, as the assignee of the entire right, title and interest in and to the same.

AND we do hereby agree properly to execute and sign without further compensation any powers of attorney, assignments, applications or other papers which may be necessary fully to secure to said Johns Manville, its successors and assigns, the invention shown and described in said application in this or any foreign country, and also to sign any divisional, continuing, substitute, reissue or renewal application or applications which may be desired by the owner of the Letters Patent or Letters Patents which may be issued for the said invention.

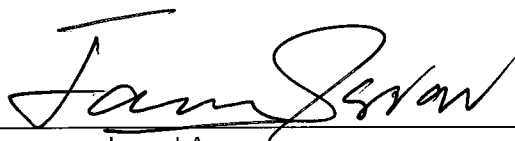
IN WITNESS WHEREOF, I have hereunto set my hand and affixed my seal on the date set out below.

Inventor's Signature  L.S.
Rajappa Tadepalli

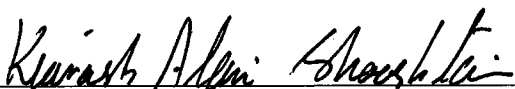
Date 12/9/2011

Inventor's Signature  L.S.
Klaus Friedrich Gleich

Date 12/5/2011

Inventor's Signature  L.S.
Jawed Asrar

Date 12/15/11

Inventor's Signature  L.S.
Kiarash Alavi Shooshtari

Date 12/5/11